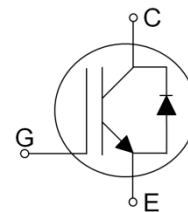


### Features:

- 1200V Field Stop Trench Technology
- High Speed Switching
- Low Conduction Loss
- Positive Temperature Coefficient
- Easy parallel Operation
- RoHS compliant
- JEDEC Qualification



### Applications :

Induction Heating, Soft switching application, UPS, Welder, Inverter

Device	Package	Marking	Remark
TGL40N120FD	TO-264	TGL40N120FD	RoHS

### Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Collector-Emitter Voltage	$V_{CES}$	1200	V
Gate-Emitter Voltage	$V_{GES}$	$\pm 20$	V
Continuous Collector Current	$I_c$	$T_C = 25\text{ }^\circ\text{C}$	80
		$T_C = 100\text{ }^\circ\text{C}$	40
Pulsed Collector Current (Note 1)	$I_{CM}$	120	A
Diode Continuous Forward Current	$T_C = 100\text{ }^\circ\text{C}$	$I_F$	40
Diode Maximum Forward Current	$I_{FM}$	120	A
Power Dissipation	$P_D$	$T_C = 25\text{ }^\circ\text{C}$	480
		$T_C = 100\text{ }^\circ\text{C}$	192
Operating Junction Temperature	$T_J$	-55 ~ 150	$^\circ\text{C}$
Storage Temperature Range	$T_{STG}$	-55 ~ 150	$^\circ\text{C}$
Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds	$T_L$	300	$^\circ\text{C}$

Notes :

(1) Repetitive rating : Pulse width limited by maximum junction temperature

### Thermal Characteristics

Parameter	Symbol	Value	Unit
Maximum Thermal resistance, Junction-to-Case	$R_{\theta JC}$ (IGBT)	0.26	$^\circ\text{C/W}$
Maximum Thermal resistance, Junction-to-Case	$R_{\theta JC}$ (DIODE)	0.95	$^\circ\text{C/W}$
Maximum Thermal resistance, Junction-to-Ambient	$R_{\theta JA}$	25	$^\circ\text{C/W}$

### Electrical Characteristics of the IGBT $T_C=25^\circ\text{C}$ , unless otherwise noted

Parameter	Symbol	Test condition	Min.	Typ.	Max.	Unit
<b>OFF</b>						
Collector – Emitter Breakdown Voltage	$BV_{CES}$	$V_{GE} = 0V, I_C = 1mA$	1200	--	--	V
Zero Gate Voltage Collector Current	$I_{CES}$	$V_{CE} = 1200V, V_{GE} = 0V$	--	--	1	mA
Gate – Emitter Leakage Current	$I_{GES}$	$V_{CE} = 0V, V_{GE} = \pm 20V$	--	--	$\pm 250$	nA
<b>ON</b>						
Gate – Emitter Threshold Voltage	$V_{GE(TH)}$	$V_{GE} = V_{CE}, I_C = 40mA$	4.5	6.5	8.5	V
Collector – Emitter Saturation Voltage	$V_{CE(SAT)}$	$V_{GE} = 15V, I_C = 40A, T_C = 25^\circ\text{C}$	--	2.0	2.6	V
		$V_{GE} = 15V, I_C = 40A, T_C = 125^\circ\text{C}$	--	2.45	--	V
<b>DYNAMIC</b>						
Input Capacitance	$C_{IES}$	$V_{CE} = 30V,$ $V_{GE} = 0V$ $f = 1MHz$	--	5150	--	pF
Output Capacitance	$C_{OES}$		--	150	--	pF
Reverse Transfer Capacitance	$C_{RES}$		--	100	--	pF
<b>SWITCHING</b> (Note 2)						
Turn-On Delay Time	$t_{d(on)}$	$V_{CC} = 600V, I_C = 40A$ $R_G = 5\Omega, V_{GE} = 15V$ Inductive Load, $T_C = 25^\circ\text{C}$	--	55	--	ns
Rise Time	$t_r$		--	80	--	ns
Turn-Off Delay Time	$t_{d(off)}$		--	200	--	ns
Fall Time	$t_f$		--	55	110	ns
Turn-On Switching Loss	$E_{ON}$		--	5.3	8.0	mJ
Turn-Off Switching Loss	$E_{OFF}$		--	1.1	1.6	mJ
Total Switching Loss	$E_{TS}$		--	6.4	9.6	mJ
Turn-On Delay Time	$t_{d(on)}$	$V_{CC} = 600V, I_C = 40A$ $R_G = 5\Omega, V_{GE} = 15V$ Inductive Load, $T_C = 125^\circ\text{C}$	--	45	--	ns
Rise Time	$t_r$		--	75	--	ns
Turn-Off Delay Time	$t_{d(off)}$		--	210	--	ns
Fall Time	$t_f$		--	115	--	ns
Turn-On Switching Loss	$E_{ON}$		--	5.6	8.4	mJ
Turn-Off Switching Loss	$E_{OFF}$		--	2.2	3.3	mJ
Total Switching Loss	$E_{TS}$		--	7.8	11.7	mJ
Total Gate Charge	$Q_g$	$V_{CC} = 600V, I_C = 40A$ $V_{GE} = 15V$	--	320	480	nC
Gate-Emitter Charge	$Q_{ge}$		--	40	60	nC
Gate-Collector Charge	$Q_{gc}$		--	150	225	nC

Notes :

(2) Not subject to production test – verified by design/characterization

**Electrical Characteristics of the DIODE**  $T_C=25^\circ\text{C}$ , unless otherwise noted

Parameter	Symbol	Test condition		Min.	Typ.	Max.	Unit
Diode Forward Voltage	$V_{FM}$	$I_F = 40\text{A}$	$T_C = 25^\circ\text{C}$	--	2.85	--	V
			$T_C = 125^\circ\text{C}$	--	2.9	--	
Reverse Recovery Time	$t_{rr}$	$I_F = 40\text{A},$ $di/dt = 200\text{A}/\mu\text{s}$	$T_C = 25^\circ\text{C}$	--	200	--	ns
			$T_C = 125^\circ\text{C}$	--	325	--	
Reverse Recovery Current	$I_{rr}$		$T_C = 25^\circ\text{C}$	--	23	--	A
			$T_C = 125^\circ\text{C}$	--	43	--	
Reverse Recovery Charge	$Q_{rr}$		$T_C = 25^\circ\text{C}$	--	2500	--	nC
			$T_C = 125^\circ\text{C}$	--	7000	--	

### IGBT Characteristics

Fig. 1 Output characteristics

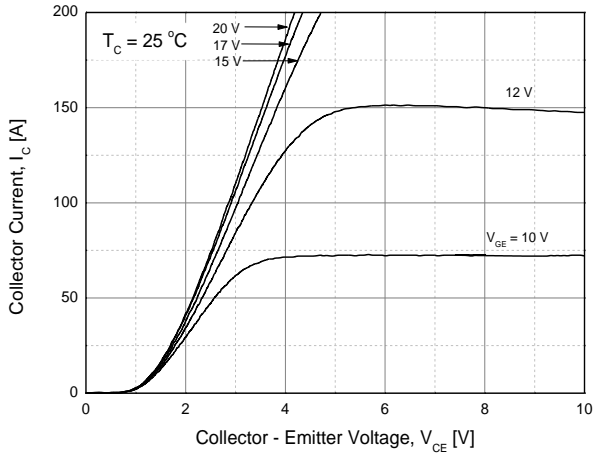


Fig. 2 Saturation voltage characteristics

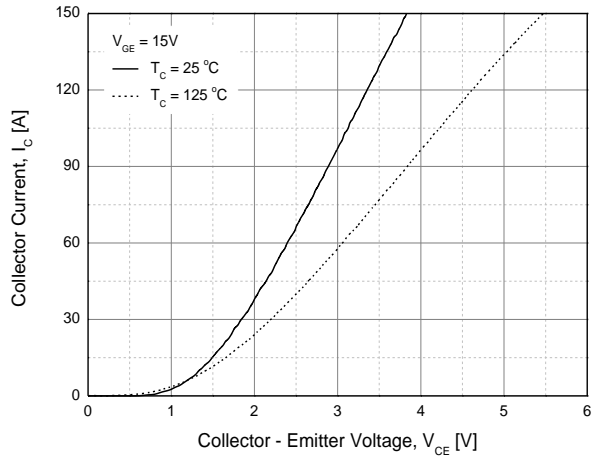


Fig. 3 Saturation voltage vs. collector current

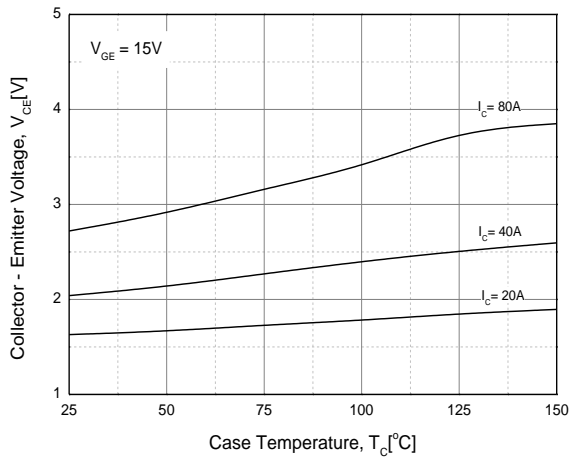


Fig. 4 Saturation voltage vs. gate bias

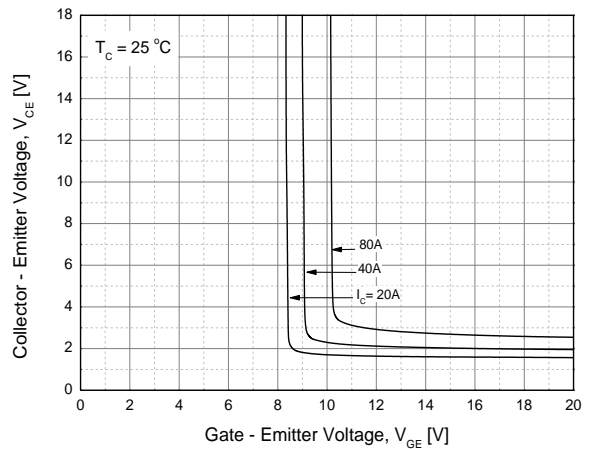


Fig. 5 Saturation voltage vs. gate bias

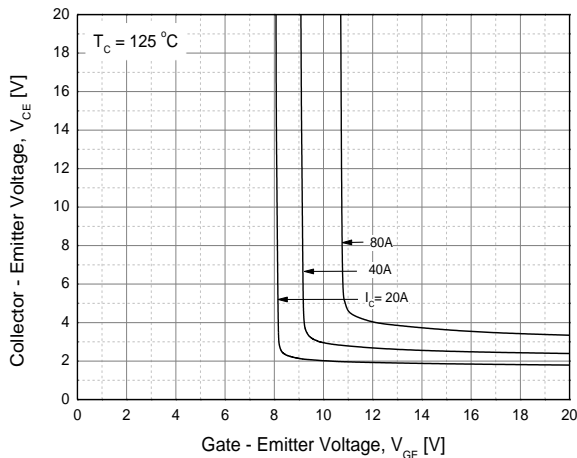
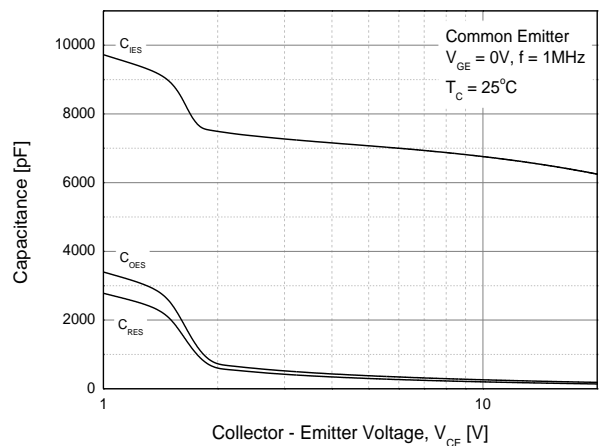


Fig. 6 Capacitance characteristics



### IGBT Characteristics

Fig. 7 Turn-on time vs. gate resistor

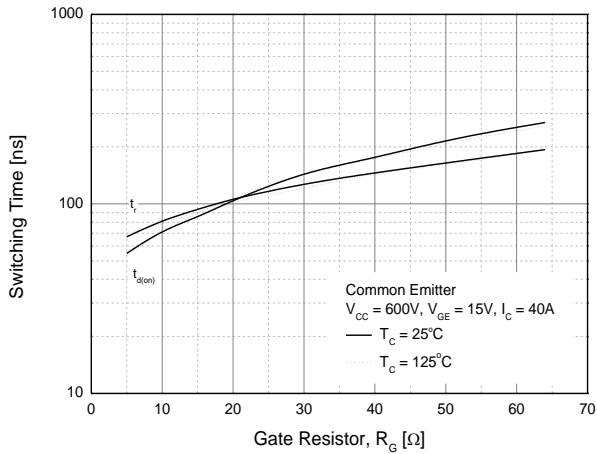


Fig. 8 Turn-off time vs. gate resistor

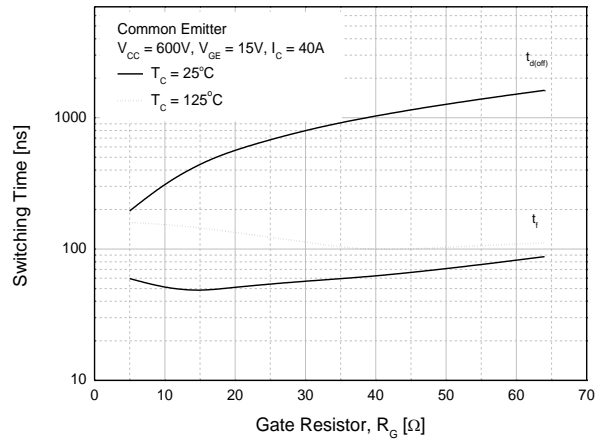


Fig. 9 Switching loss vs. gate resistor

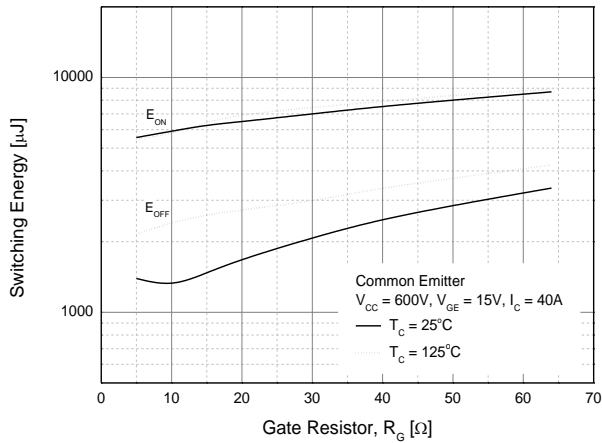


Fig. 10 Turn-on time vs. collector current

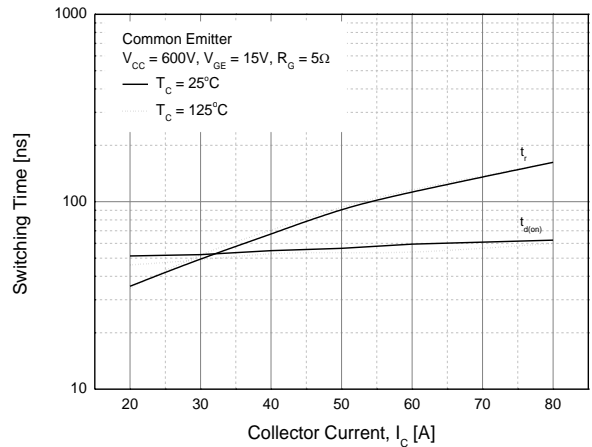


Fig. 11 Turn-off time vs. collector current

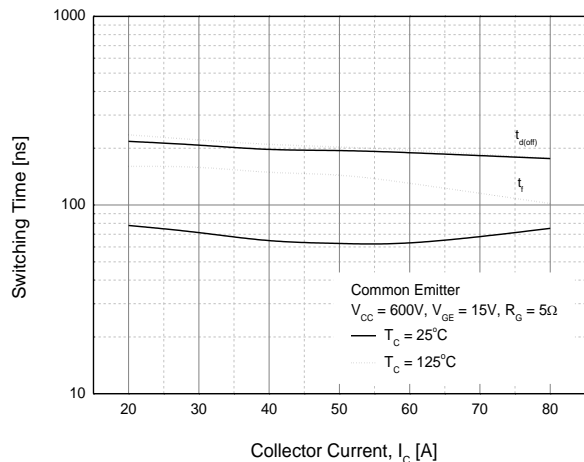
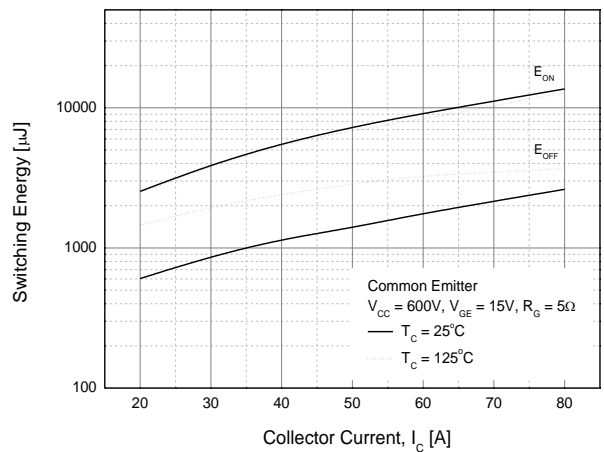


Fig. 12 Switching loss vs. collector current



# IGBT Characteristics

Fig. 13 Gate charge characteristics

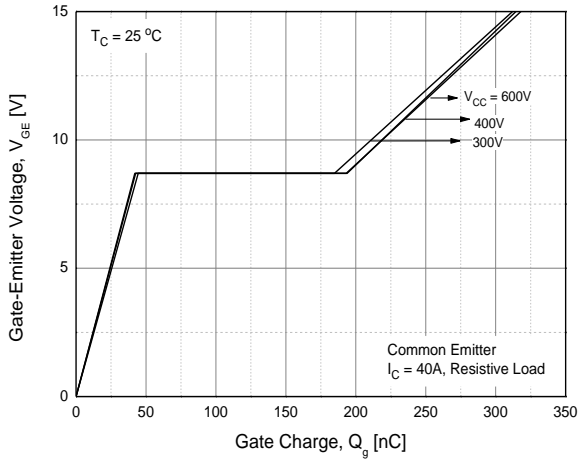


Fig. 14 SOA

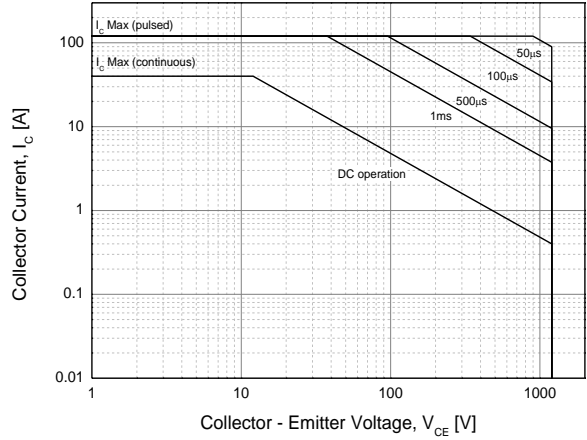


Fig. 15 RBSOA

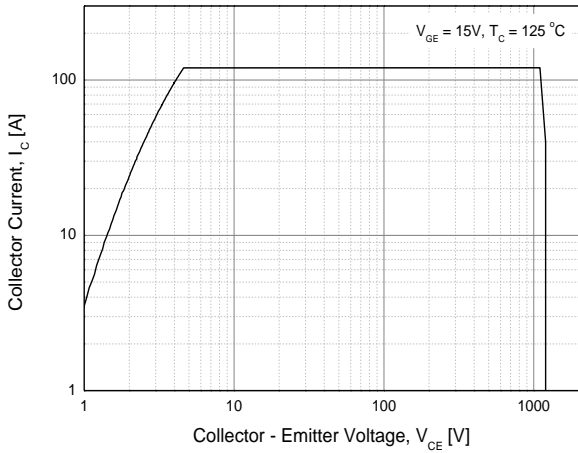


Fig. 16 Transient thermal impedance of IGBT

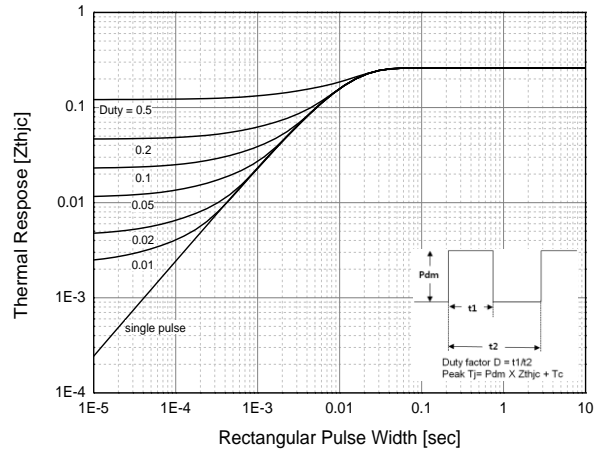
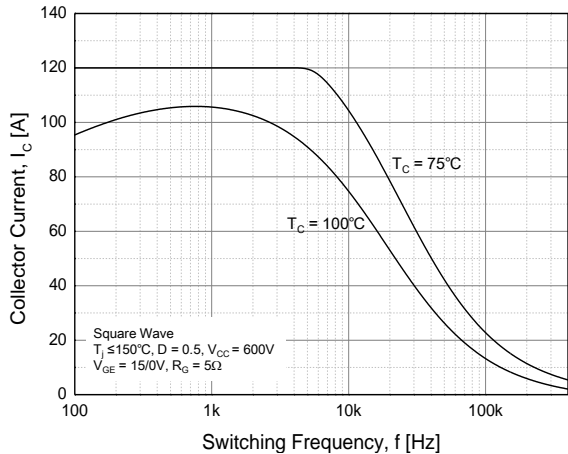


Fig. 17 Load Current vs. Frequency



## Diode Characteristics

Fig. 18 Conduction characteristics

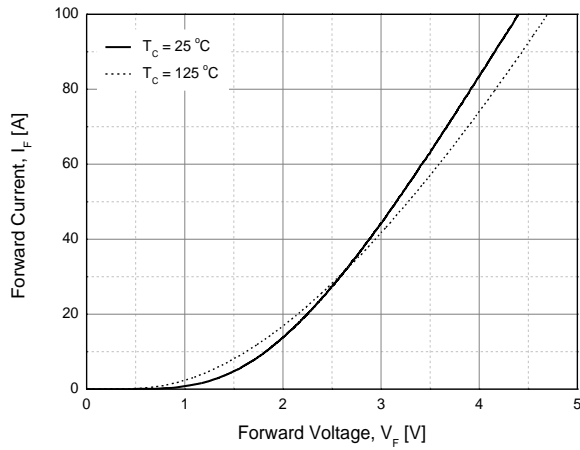


Fig. 19 Reverse recovery current vs. forward current

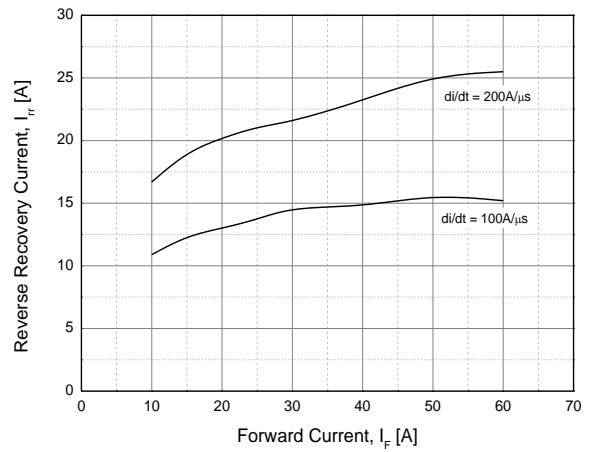


Fig. 20 Reverse recovery charge vs. forward current

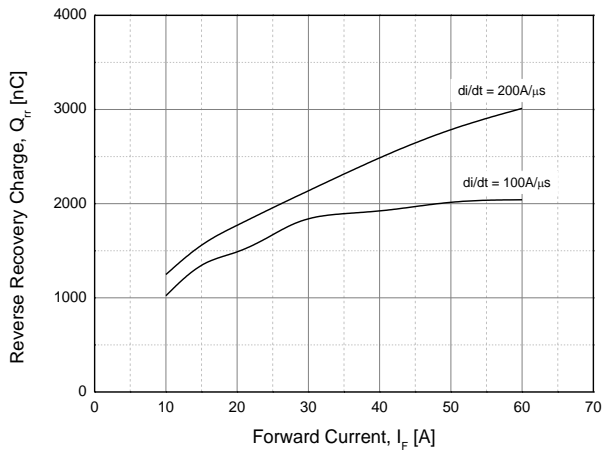
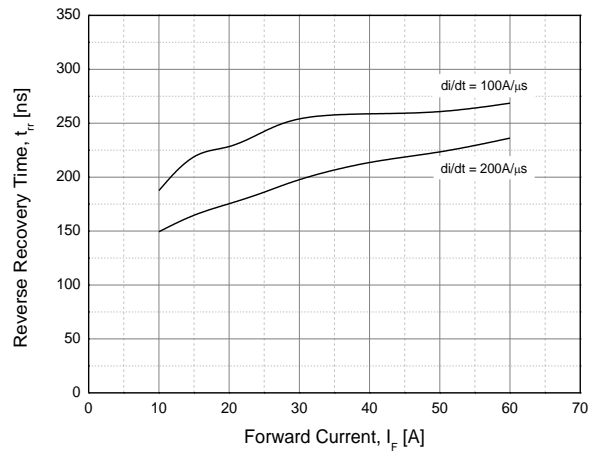
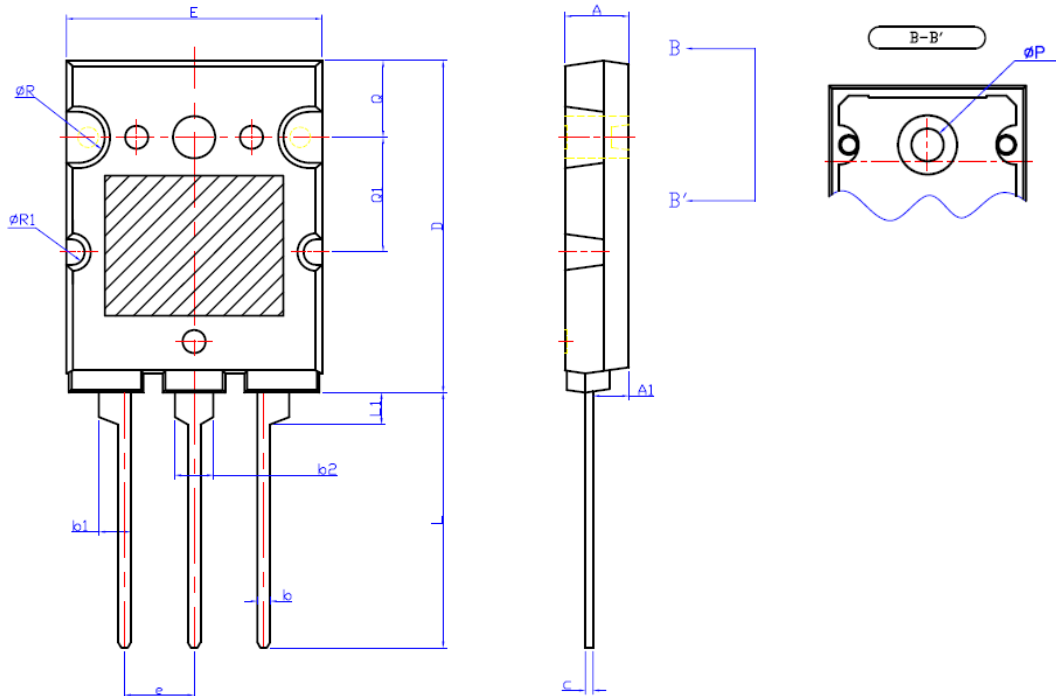


Fig. 21 Reverse recovery time vs. forward current



### TO-264 MECHANICAL DATA



SYMBOL	MIN	NDM	MAX
A	4.80	5.00	5.20
A1	2.50	2.80	3.10
b	0.90	1.00	1.25
b1	2.30	2.50	2.70
b2	2.80	3.00	3.20
c	0.50	0.60	0.85
D	25.80	26.00	26.20
E	19.80	20.00	20.20
e	5.15	5.45	5.75
L	19.50	20.00	20.50
L1	2.40	2.50	2.60
$\phi P$	3.00	3.20	3.40
Q	5.80	6.00	6.20
Q1	8.80	9.00	9.20
$\phi R$	(2.00)		
$\phi R1$	(1.00)		

#### Disclaimer

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